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Research Paper

Terahertz Characteristics of InGaAs with Periodic InAlAs Insertion Layers

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Abstract

We presented terahertz (THz) generation and detection characteristics of an InGaAs epilayer with periodic-InAlAs insertion layers (InGaAs-PIL). The peak-to-peak current signal (PPCS) from a THz transmitter with the InGaAs-PIL was three times higher than that of a simple InGaAs epilayer. Moreover, the detection properties of a THz receiver with the low-temperature grown (LT) InGaAs-PIL showed more than twenty-five times higher than that of the LT-InGaAs epilayer. The PPCS of the LT-InGaAs-PIL was significantly improved with increasing the periods of the InAlAs insertion layer.

Keywords: Terahertz, Molecular beam epitaxy, Low-temperature growth, Indium gallium arsenide, Multiple quantum well

I. Introduction

Usually, *so called* terahertz (THz) wave is related to the frequency range from 0.1 to 10 THz corresponding to the wavelengths from 30 to 3000 μm and the energy gaps from 0.42 to 42 meV, respectively. THz wave has been actively studied for the applications of astronomy, analytical science, communication technology, and biological science due to low energy loss and high frequency [1-5]. THz wave can achieve faster data transmission and have more information than GHz system in electronics. Also in optics, THz wave can apply to imaging, sensing, and absorption spectrum. Furthermore, THz can be used for non-destructive and non-harmful tomography to live objects. However, it has been difficult for THz region to realize for the applications. For example, THz characteristics for electronic applications using the transport type, such as impact ionization avalanche transit-time diode, Gunn diode, and resistance temperature detector, significantly decrease over the frequency of 0.1 THz. Also, THz characteristics of optical applications using transition type such as quantum cascade laser decrease under the frequency of 10 THz. Recently, THz technologies including transmitters

and receivers have been drastically improved mostly due to successful supply of femto-second (fs) pulse laser such as a Ti:sapphire laser.

Typically, low-temperature (LT) grown GaAs, which has high resistivity, high mobility, and short carrier lifetime [6,7], have been used for the THz generation and detection using photoconductive effect [8,9]. The LT-GaAs layer is typically grown at the substrate temperature (T_s) around 300 °C, which is relatively lower than its optimum T_s window, under arsenic (As)-rich condition [10,11]. As a result, the LT-GaAs has many defects largely consisting of a high density of As antisites. The antisite, As_{Ga} , can generate defect levels in the energy band gap, working as non-radiative recombination centers of carriers. Non-radiative recombination process of carriers can result in the decrease in carrier lifetime, usually less than 200 fs [12]. In addition, the resistance of the LT-GaAs is measured over $\sim\text{M}\Omega$. In terms of optical communication system using an optical fiber, GaAs ($E_G = 1.42$ eV, $\lambda = 873$ nm) is not suitable for the wavelength windows of 1.3 and 1.5 μm . On the other hand, $\text{In}_{0.53}\text{Ga}_{0.47}\text{As}$ ($E_G = 0.816$ eV, $\lambda = 1520$ nm) lattice-matched to InP can be used to THz application for the wavelength window of 1.55 μm in fiber-optic communication. However, LT-InGaAs has lower resistance and longer carrier lifetime than LT-GaAs [12-14]. These intrinsic properties may lead to relatively lower amplitude of current signal and shorter cutoff frequency compared to those of LT-GaAs.

[†]This study was conducted while the author was working at Korea Research Institute of Standards and Science

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In this paper, the THz characteristics of $\text{In}_{0.53}\text{Ga}_{0.47}\text{As}$ (InGaAs) are improved by periodic $\text{In}_{0.52}\text{Al}_{0.48}\text{As}$ (InAlAs) insertion layer (InGaAs-PIL). For comparison, simple InGaAs epilayers grown at different conditions were investigated.

II. Experimental details

InGaAs epilayers and InGaAs-PIL were grown on semi-insulating InP:Fe (100) substrate by using a Riber32P molecular beam epitaxy (MBE) with solid sources. The InGaAs epilayers and InGaAs-PIL were lattice-matched to InP. The growth rate and V/III ratio for InGaAs were estimated to be 2.78 s^{-1} and 12, respectively. All the epilayers were grown on a 300 nm-thick InAlAs buffer layer. The growth temperatures for the growth of InGaAs were $250 \text{ }^\circ\text{C}$ (LT-InGaAs) and $480 \text{ }^\circ\text{C}$ (HT-InGaAs). The InGaAs-PIL was grown at the growth temperatures of $250 \text{ }^\circ\text{C}$ (LT-InGaAs-PIL) and $400 \text{ }^\circ\text{C}$ (HT-InGaAs-PIL). InGaAs total thickness of the LT-InGaAs-PIL was fixed to 500 nm. Three different periods (10, 25, and 50) for the InGaAs-PIL with a 10 nm-thick InAlAs were inserted to the InGaAs layer to get high resistance. The InGaAs layers of LT-InGaAs and LT-InGaAs-PIL were doped with beryllium (Be) at a doping concentration of 210^{18} cm^{-3} for carrier compensation. LT-GaAs was annealed inside an MBE chamber at $600 \text{ }^\circ\text{C}$ for 10 min for recrystallization. LT-InGaAs and LT-InGaAs-PIL were annealed in a rapid thermal annealing system at $550 \text{ }^\circ\text{C}$ for 10 min for recrystallization and activation of Be working as p-type dopants. Table I shows the growth parameters for the samples. Figure 1 shows a layout of photo-mask for

transmission line antenna (Tx) and dipole antenna (Rx). For the Tx, the line width of transmission line was $10 \text{ }\mu\text{m}$. The distance between transmission lines was $80 \text{ }\mu\text{m}$. For the Rx, a Tx was added with a dipole antenna having length of $20 \text{ }\mu\text{m}$ and distance of $5 \text{ }\mu\text{m}$ between two dipoles. For the fabrication of THz devices, electrodes with Ti (30 nm)/Au (200 nm) were realized by using an e-beam evaporator. To verify characteristics of fabricated photoconductive antennas, we used a homemade THz-time domain spectroscopy (TDS) system that was driven by femto-second laser pulses to generate and detect THz waves. We used two off-axis parabolic reflectors to collimate and focus THz waves onto Rx. Laser pulses generated by a Ti:sapphire mode-locked laser with durations of 60 fs at a repetition rate of 83 MHz. The center wavelength of the pulses is 780 nm. A more detailed description of THz-TDS system is presented in a previous report [15]. The measured THz signal was converted to frequency spectrum by fast Fourier transformation for analyzing frequency dependent characteristics.

III. Results and discussion

Figure 2(a) shows the thickness-dependent secondary ion mass spectroscopy (SIMS) profile of LT-InGaAs-PIL (25). While the SIMS intensities of As and In were consistent with time, the profiles of Ga and Al were changed. Figure 2(b) shows 2θ - ω scanning curves of HT-InGaAs-PIL and LT-InGaAs-PIL (50) obtained from high resolution X-ray diffraction (HR-XRD). For the HT-InGaAs-PIL, the several satellite peaks were clearly observed in the HR-XRD rocking curve. However, there was no peak for the LT-InGaAs-PIL (50). This is due to the low crystalline quality for the LT-InGaAs-PIL with defects in the epilayer and at the interface between InGaAs and InAlAs.

Figure 3 shows the transmission electron microscopy (TEM) images of (a) LT-InGaAs epilayers and (b) LT-InGaAs-PIL (50), where the defects such as As_{Ga} antisites were observed. These defects can lead to extremely short carrier lifetime less than 1 picosecond (ps) [16,17].

The optical properties of LT-InGaAs-PIL and HT-InGaAs-PIL were analyzed by using PL spectroscopy. In Fig. 4(a), the emission wavelength of HT-InGaAs-PIL was measured to be 1590 nm at 10 K. However, the PL spectrum was not observed for the LT-InGaAs-PIL (50) mainly due to high non-radiative recombination rate of

Table I. Growth parameters of InGaAs, InGaAs-PIL, and LT-GaAs.

Sample	Growth Temperature	InGaAs total thickness	Thickness of a period (InGaAs/InAlAs)	Periods
HT-InGaAs	$480 \text{ }^\circ\text{C}$	$1 \text{ }\mu\text{m}$	$1 \text{ }\mu\text{m}$	n/a
HT-InGaAs-PIL	$400 \text{ }^\circ\text{C}$	500 nm	10 nm/10 nm	50
LT-InGaAs	$250 \text{ }^\circ\text{C}$	$1 \text{ }\mu\text{m}$	$1 \text{ }\mu\text{m}$	n/a
LT-InGaAs-PIL (10)	$250 \text{ }^\circ\text{C}$	500 nm	50 nm /10 nm	10
LT-InGaAs-PIL (25)	$250 \text{ }^\circ\text{C}$	500 nm	20 nm /10 nm	25
LT-InGaAs-PIL (50)	$250 \text{ }^\circ\text{C}$	500 nm	10 nm /10 nm	50
LT-GaAs	$250 \text{ }^\circ\text{C}$	$1 \text{ }\mu\text{m}$	$1 \text{ }\mu\text{m}$	n/a

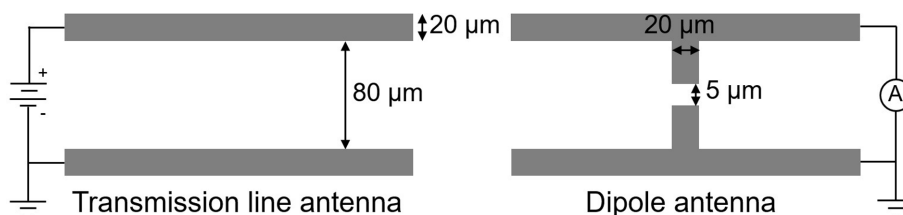


Figure 1. Configuration of transmission line antenna for THz generation and dipole antenna for THz detection.

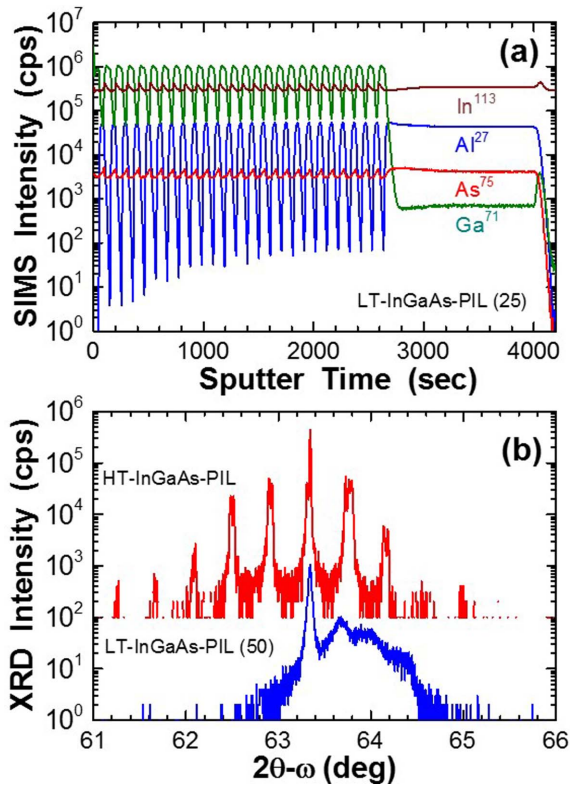


Figure 2. (a) Thickness-dependent SIMS profile for changing measurement of In, Ga, Al, and As in LT-InGaAs-PIL (25) and (b) 2theta-omega scanning for determination of crystalline quality of InGaAs-PIL.

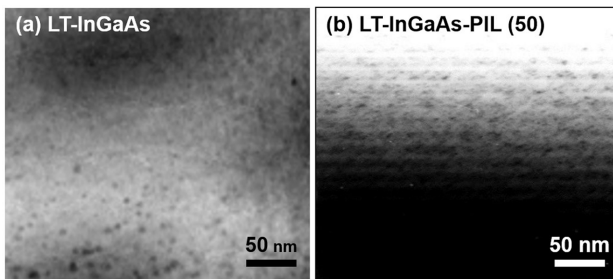


Figure 3. Observation of high As_{Ga} antisite TEM analysis in (a) LT-InGaAs and (b) LT-InGaAs-PIL (50).

carriers, mainly caused by a large number of defects, over radiative component. Figure 4(b) shows the decay curves of LT-InGaAs, LT-InGaAs-PIL (50), and HT-InGaAs-PIL. The LT-InGaAs and LT-InGaAs-PIL (50) show fast decay characteristics, indicating to short carrier lifetime, due to effect of the non-radiative recombination component. These properties may increase the ability of THz generation and detection. For the characterization of carrier lifetime, the back side of a SI-InP substrate was polished to enhance the transmission of a probe beam. Carrier lifetimes of LT-InGaAs, LT-InGaAs-PIL (50) and HT-InGaAs-PIL were measured to be 1.4, 0.95 and 3.6 ps, respectively. The very short carrier lifetime at picosecond level is largely due to defects, mostly As_{Ga} antisites [18]. That is, trapping level for carrier due to defects can result in short carrier lifetime [19]. Since LT-growth of InAlAs typically generates more

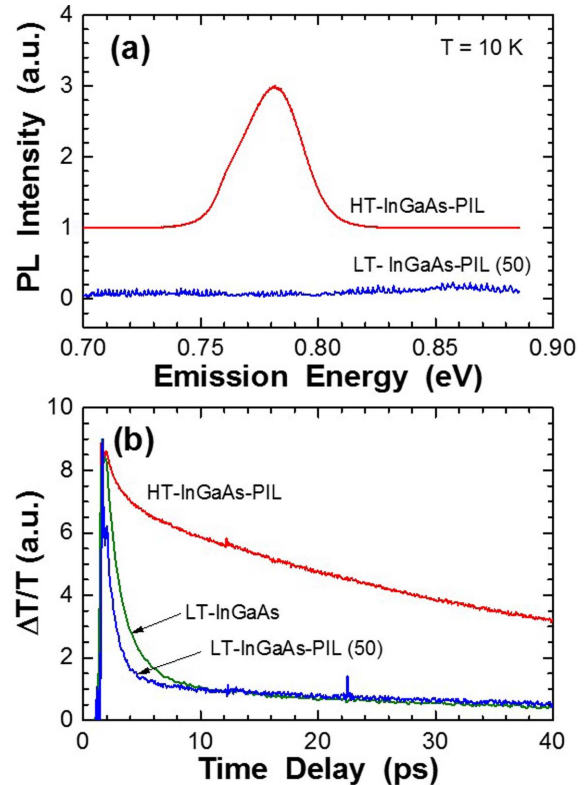


Figure 4. Radiation characteristics of (a) HT-InGaAs-PIL and LT-InGaAs-PIL (50) using PL spectroscopy and (b) carrier life time measurement of HT-InGaAs-PIL, LT-InGaAs-PIL (50), and LT-InGaAs using pump-probe spectroscopy.

defects between InAlAs and InGaAs, carrier lifetime of LT-InGaAs-PIL was shorter than that of LT-InGaAs. For the HT-InGaAs-PIL, the InGaAs layer has relatively low defects. However, the InAlAs layer has many As antisites, which can work as carrier trapping sites. This can lead to high resistance and short carrier lifetime, enhancing the THz characteristics.

Figure 5 shows current signals and spectra of THz transmitters with a SI-GaAs substrate, HT-InGaAs, and HT-InGaAs-PIL. In case of photoconductive effect, as a femto-second laser pulse arrive at the transmission line of the Tx, holes and electrons are generated because the energy of the 780 nm laser beam is greater than that of the sample's band gap. After that, the DC bias voltage on the order of 10^6 V/m is applied to the Tx. The generated carriers are immediately accelerated by the electric field, a resulting transient photocurrent flows and a dipole moment is formed in the substrate. THz waves which are proportional to Maxwell's equation radiate to free space. High resistive silicon lens was used to collimate the THz waves. The laser beam should be focused onto positive bias side due to asymmetry THz generation characteristic for DC bias pole. In case of photo-Dember effect, the generated electrons and holes move in opposite directions, and the band bending is accelerated by the dipole to generate THz wave. THz signals were detected by LT-

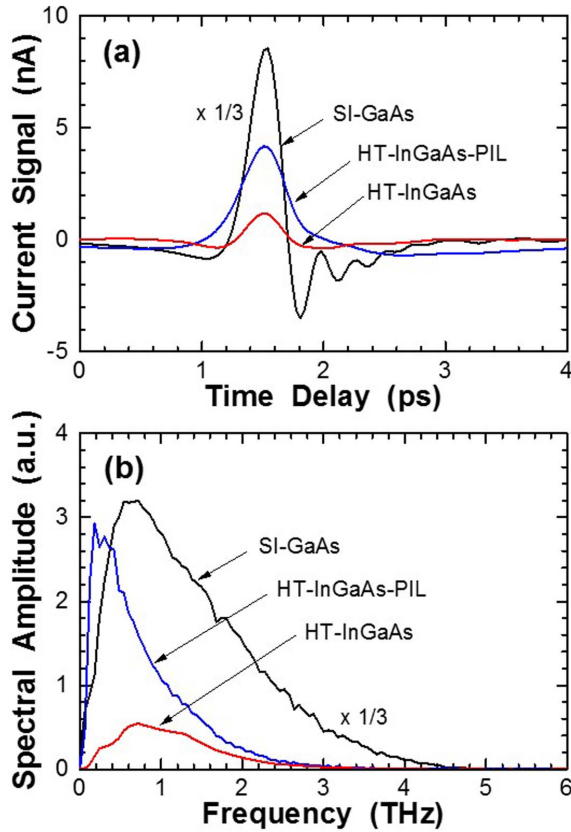


Figure 5. THz generation characteristics of SI-GaAs, HT-InGaAs, and HT-InGaAs-PIL for (a) current signals and (b) spectra of THz.

GaAs. The peak-to-peak current signal (PPCS) of the SI-GaAs, HT-InGaAs, and HT-InGaAs-PIL were measured to be 36, 1.6, and 5 nA, respectively. The energy of generated THz wave from the SI-GaAs, HT-InGaAs, and HT-InGaAs-PIL were existed up to 4.5, 3, and 3 THz, respectively, where the SI-GaAs generated the highest current signal due to high resistance. The HT-InGaAs has lower current signal and shorter cutoff frequency compared to those of the SI-GaAs. According to the previous reports, when the growth temperature for InAlAs was from 350 to 400 °C, electrical properties was changed to semi-insulator due to high density of defects [20]. As a result, the InGaAs-PIL with InAlAs has high resistance. Although the PPCS of HT-InGaAs-PIL was increased over three times higher than that of InGaAs epilayer, cutoff frequency still remains at 3 THz.

Figure 6 shows current signals and spectra of THz receivers based on LT-GaAs, LT-InGaAs, and LT-InGaAs-PIL. The THz detection method is photoconductive sampling, in which the THz pulse irradiated to the antenna forms an electric field between the electrodes to detect the current proportional to the THz intensity. The generated THz electric field lasts a few ps. All THz signals were obtained by SI-GaAs under DC bias voltage on the order of 10^6 V/m. The PPCS and cutoff frequency for LT-GaAs (LT-InGaAs) were 22 nA (0.5 nA) and 4.5 THz (3 THz),

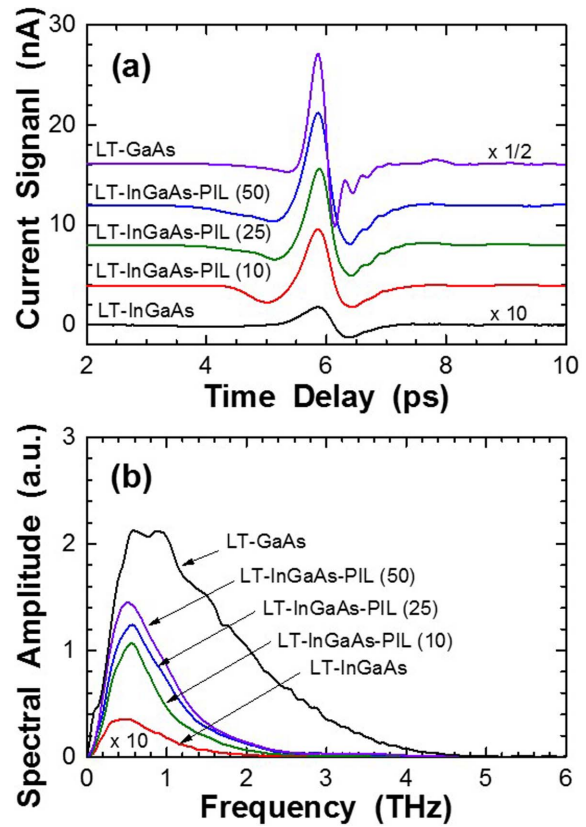


Figure 6. THz detection characteristics of LT-GaAs, LT-InGaAs epilayer, and LT-InGaAs-PIL for (a) current signals and (b) spectra of THz.

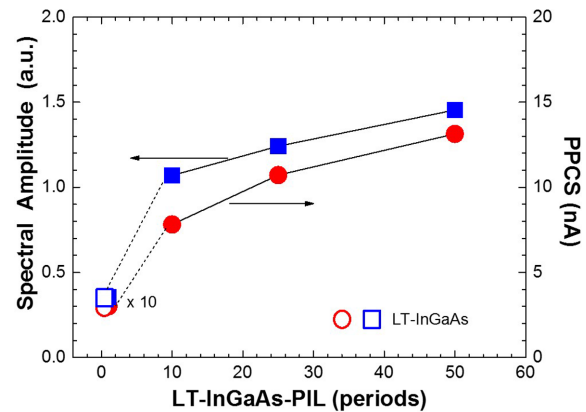


Figure 7. Increased THz detection properties depending on the periods of InAlAs.

respectively. The PPCSs of InGaAs-PIL (10), HT-InGaAs-PIL (25), and HT-InGaAs-PIL (50) were measured as 8, 10.5, and 13.0 nA, respectively, which are larger than that of LT-InGaAs. However, the cutoff frequency of LT-InGaAs-PIL was not changed with periods. This is related that the InAlAs layers can generate higher photoconductive effect for a THz device due to high resistance and trapping effect.

Figure 7 shows the summary on spectral amplitude and the PPCS of LT-InGaAs-PIL with different InAlAs periods. Although the active InGaAs layer had same thickness for

all samples, the current signal was effectively increased by inserting the InAlAs layers.

IV. Conclusions

In summary, for the enhancement of THz generation and detection, InAlAs layers were periodically inserted to an InGaAs epilayer to get relatively high resistance and short carrier lifetime. The PPCS from a THz transmitter with the InGaAs-PIL (5 nA) showed three times higher than that of a simple InGaAs epilayer without the InAlAs insertion layer (1.6 nA). Moreover, the detection properties of a THz receiver with the LT-InGaAs-PIL (8 nA) showed sixteen times higher than that of the LT-InGaAs epilayer (0.5 nA). The PPCS of the LT-InGaAs-PIL was improved from 8 to 13 nA with increasing the periods of the InAlAs layers from 10 to 50. This is related that InAlAs layers can make higher photoconductive effect for THz device due to high resistance and trapping effect via defects.

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